

DATA SHEET

LEAD FREE CHIP RESISTORS

RC_P series
 $\pm 0.5\%$, $\pm 1\%$, $\pm 5\%$

Sizes 0100/0201/0402/0603/0805/
1206/1210/1218/2010/2512



SCOPE

This specification describes RC series chip resistors with made by thick film process.

APPLICATIONS

- All general purpose application

FEATURES

- Total lead free without RoHS exemption
- Halogen Free Epoxy
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space

ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

RC XXXX X X X XX XXXX P
 (1) (2) (3) (4) (5) (6) (7)

(1) SIZE

0100/0201/0402/0603/0805/1206/1210/1218/2010/2512

(2) TOLERANCE

D = $\pm 0.5\%$

F = $\pm 1.0\%$

J = $\pm 5.0\%$ (for jumper ordering, use code of J)

(3) PACKAGING TYPE

R = Paper taping reel

K = Embossed taping reel

S = ESD safe reel (0100 only)

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Based on spec.

(5) TAPING REEL

07= 7 inch dia. Reel

13= 13 inch dia. Reel

7N = 7 inch dia. Reel, ESD safe reel (0100 only)

(6) RESISTANCE VALUE

There are 2~4 digits indicated the resistance value.

Letter R/K/M is decimal point.

Example:

97R6 = 97.6Ω

9K76 = 9760Ω

1M = $1,000,000\Omega$

(7) DEFAULT CODE

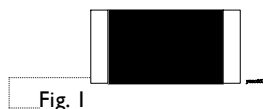
Letter P is lead free (without RoHS exemption)

ORDERING EXAMPLE

The ordering code for a RC0402 0.0625W chip resistor value 100K Ω with $\pm 5\%$ tolerance, supplied in 7-inch tape reel of 10,000 units per reel is: RC0402JR-07100KP.

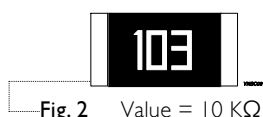
MARKING

RC0100 / RC0201 / RC0402



No Marking

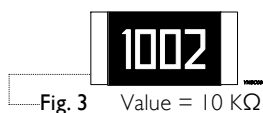
RC0603



E24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros

RC0805 / RC1206 / RC1210 / RC1218 / RC2010 / RC2512



E24/E96 series: 4 digits

First three digits for significant figure and 4th digit for number of zeros

Note

For further marking information, please see special data sheet "Chip resistors marking".

CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environmental influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Nibarrier) are added, as shown in Fig.4.

Outlines

For dimensions, please refer to Table I

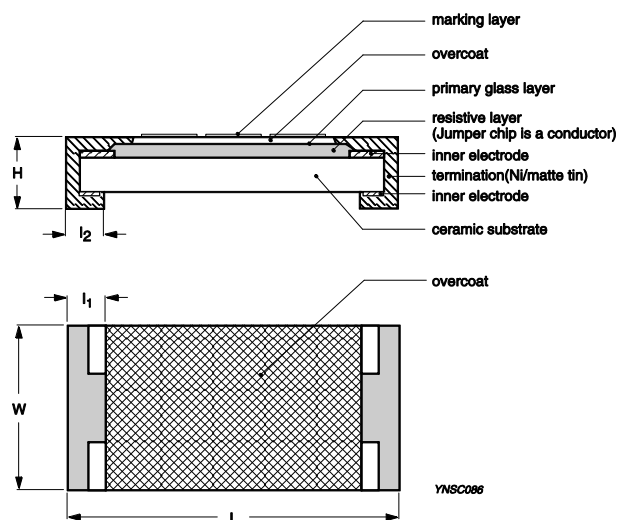


Fig. 4 Chip resistor outlines

DIMENSION

Table 1

TYPE	L (mm)	W (mm)	H (mm)	l ₁ (mm)	l ₂ (mm)
RC0100	0.40±0.02	0.20±0.02	0.13±0.02	0.10±0.03	0.10±0.03
RC0201	0.60±0.03	0.30±0.03	0.23±0.03	0.10±0.05	0.15±0.05
RC0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
RC0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
RC0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
RC1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
RC1210	3.10±0.10	2.60±0.15	0.50±0.10	0.45±0.15	0.50±0.20
RC1218	3.10±0.10	4.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
RC2010	5.00±0.10	2.50±0.15	0.55±0.10	0.45±0.15	0.50±0.20
RC2512	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	0.50±0.20

ELECTRICAL CHARACTERISTICS

Table 2

TYPE	RESISTANCE RANGE	CHARACTERISTICS					Jumper Criteria
		Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance	
RC0100	5% (E24) 1Ω≤R≤22MΩ (0201: Max 10MΩ, 0100/1218: Max. 1MΩ) 1% (E24/E96) 1Ω≤R≤10MΩ (0100/1218: Max. 1MΩ) 0.5% (E24/E96) 10Ω≤R≤1MΩ Jumper<50mΩ	-55 °C to +125 °C	15V	30V	30V	1Ω≤R≤10Ω: -200~+600ppm/°C 10Ω<R≤100Ω: ±370ppm/°C 100Ω<R≤1MΩ: ±250ppm/°C	Rated Current 0.5A Max. Current 1A
RC0201			25V	50V	50V	1Ω≤R≤10Ω: -100~+500ppm/°C 10Ω<R≤100Ω: ±300ppm/°C 100Ω<R≤10MΩ: ±200ppm/°C	Rated Current 0.5A Max. Current 1A
RC0402			50 V	100 V	100 V	1Ω≤R≤10Ω: ±350ppm/°C 10Ω<R≤100Ω: ±200ppm/°C 100Ω<R≤10MΩ: ±150ppm/°C 10MΩ<R≤22MΩ: ±200ppm/°C	Rated Current 1A Max. Current 2A
RC0603			75V	150 V	150 V	1Ω≤R≤10Ω: ±300ppm/°C 10Ω<R≤100Ω: ±200ppm/°C 100Ω<R≤10MΩ: ±150ppm/°C 10MΩ<R≤22MΩ: ±200ppm/°C	Rated Current 1A Max. Current 2A
RC0805			150 V	300 V	300 V	1Ω≤R≤10Ω: ±300ppm/°C 10Ω<R≤100Ω: ±150ppm/°C 100Ω<R≤10MΩ: ±100ppm/°C 10MΩ<R≤22MΩ: ±200ppm/°C	Rated Current 2A Max. Current 5A
RC1206			200 V	400 V	500 V		Rated Current 2A Max. Current 10A
RC1210							Rated Current 2A Max. Current 10A
RC1218			200V	500 V	500V	1Ω≤R≤10Ω: ±300ppm/°C 10Ω<R≤100Ω: ±100ppm/°C 100Ω<R≤10MΩ: ±100ppm/°C 10MΩ<R≤22MΩ: ±200ppm/°C	Rated Current 6A Max. Current 10A
RC2010							Rated Current 2A Max. Current 10A
RC2512							Rated Current 2A Max. Current 10A

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet “Chip resistors mounting”

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	RC0100	RC0201	RC0402	RC0603	RC0805	RC1206	RC1210	RC1218	RC2010	RC2512
Paper taping reel (R)	7" (178 mm)	20,000	10,000	10,000	5,000	5,000	5,000	5,000	---	---	---
	13" (330 mm)	80,000	50,000	50,000	20,000	20,000	20,000	20,000	---	---	---
ESD safe reel (S)	7" (178 mm)	40,000	---	---	---	---	---	---	---	---	---
Embossed taping reel	7" (178 mm)	---	---	---	---	---	---	---	4,000	4,000	4,000

NOTE

For tape and reel specification/dimensions, please refer to data sheet “Chip resistors packing”.

FUNCTIONAL DESCRIPTION**OPERATING TEMPERATURE RANGE**

RC0402 to RC2512 Range: -55°C to +155°C (Fig. 5-1)

RC0100 to RC0201 Range: -55°C to +125°C (Fig. 5-2)

POWER RATING

Each type rated power at 70 °C:

RC0100=1/32W

RC0201=1/20 W

RC0402=1/16 W

RC0603=1/10W

RC0805=1/8W

RC1206=1/4W

RC1210=1/2W

RC1218=1W

RC2010=3/4W

RC2512=1W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

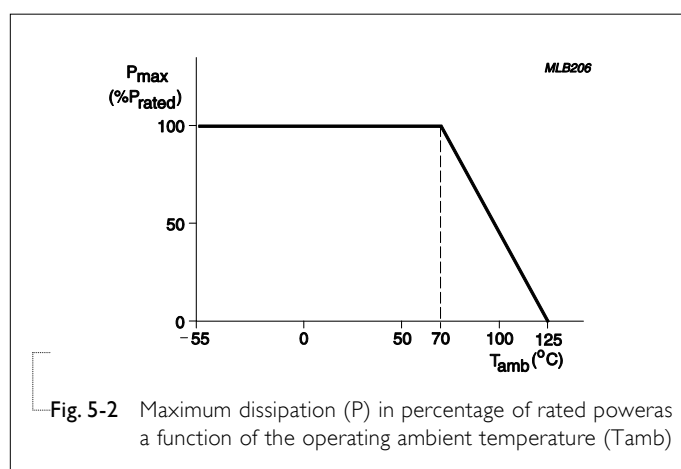
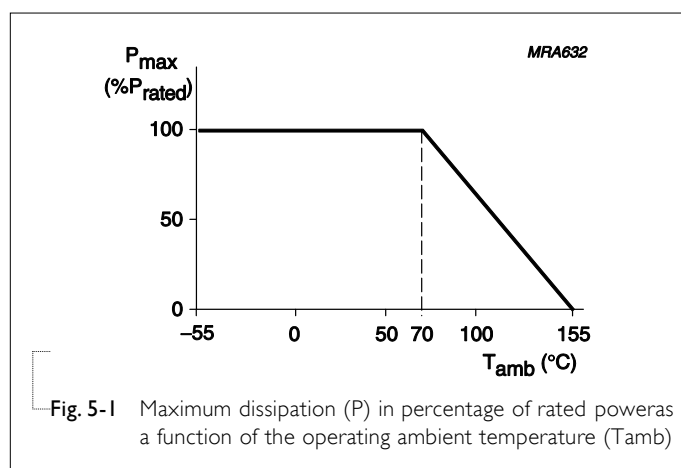
$$V = \sqrt{(P \times R)}$$

Where

V = Continuous rated DC or
AC (rms) working voltage (V)

P = Rated power (W)

R = Resistance value (Ω)



TESTS AND REQUIREMENTS

Table 8 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of Resistance (T.C.R.)	IEC 60115-1 4.8	At +25/-55 °C and +25/+125 °C Formula: $T.C.R. = \frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$ Where t_1 = +25 °C or specified room temperature t_2 = -55 °C or +125 °C test temperature R_1 = resistance at reference temperature in ohms R_2 = resistance at test temperature in ohms	Refer to table 2
Life/ Endurance	MIL-STD-202G Method 108A IEC 60115-1 4.25.1	At 70±5°C for 1,000 hours; RCWV applied for 1.5 hours on and 0.5 hour off, still air required	±(1%+0.05Ω) for D/F tol ±(3%+0.05Ω) for J tol <100mR for jumper
High Temperature Exposure	MIL-STD-202G Method 108A IEC 60115-1 4.25.3	1,000 hours at maximum operating temperature depending on specification, unpowered.	±(1%+0.05Ω) for D/F tol ±(2%+0.05Ω) for J tol <50mR for jumper
Moisture Resistance	MIL-STD-202G Method 106F IEC 60115-1 4.24.2	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered Parts mounted on test-boards, without condensation on parts	±(0.5%+0.05Ω) for D/F tol ±(2%+0.05Ω) for J tol <100mR for jumper
Humidity	IEC 60115-1 4.37	Steady state for 1000 hours at 40 °C / 95% R.H. RCWV applied for 1.5 hours on and 0.5 hour off	±(1%+0.05Ω) for D/F tol ±(2%+0.05Ω) for J tol <100mR for jumper
Thermal Shock	MIL-STD-202G Method 107G	-55/+125°C Note Number of cycles required is 300 Devices mounted Maximum transfer time is 20 seconds Dwell time is 15 minutes. Air - Air	±(0.5%+0.05Ω) for D/F tol ±(1%+0.05Ω) for J tol <50mR for jumper
Short Time Overload	IEC 60115-1 4.13	2.5 times RCWV or maximum overload voltage which is less for 5 seconds at room temperature	±(1%+0.05Ω) for D/F tol ±(2%+0.05Ω) for J tol <50mR for jumper No visible damage
Board Flex/ Bending	IEC 60115-1 4.33	Device mounted or as described only 1 board bending required bending time: 60±5 seconds 0100/0201/0402:5mm; 0603/0805:3mm; 1206 and above:2mm	±(1%+0.05Ω) for D/F/J Tol <50mR for jumper No visible damage

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	IPC/JEDECJ-STD-002B test B IEC 60068-2-58	Electrical Test not required Magnification 50X SMD conditions: 1st step: method B, aging 4 hours at 155 °C dry heat 2nd step: leadfree solder bath at 245±3 °C Dipping time: 3±0,5 seconds	Well tinned (>95% covered) No visible damage
-Leaching	IPC/JEDECJ-STD-002B test D IEC 60068-2-58	Leadfree solder ,260°C, 30 seconds immersion time	No visible damage
-Resistance to Soldering Heat	MIL-STD-202F Method 210F IEC 60068-2-58	Condition B, no pre-heat of samples Leadfree solder, 260 °C ±5°C, 10 ±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(0,5%+0.05Ω) for D/F tol ±(1%+0.05Ω) for J tol <50mR for jumper No visible damage

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
----------	------	---------------------	-------------

Version 0	Aug. 22, 2014	-	- First issue of this specification
-----------	---------------	---	-------------------------------------

“Yageo reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN.”